THYTRONIC PRO N
Protection Relays

NA21

FEEDER PROTECTION RELAY

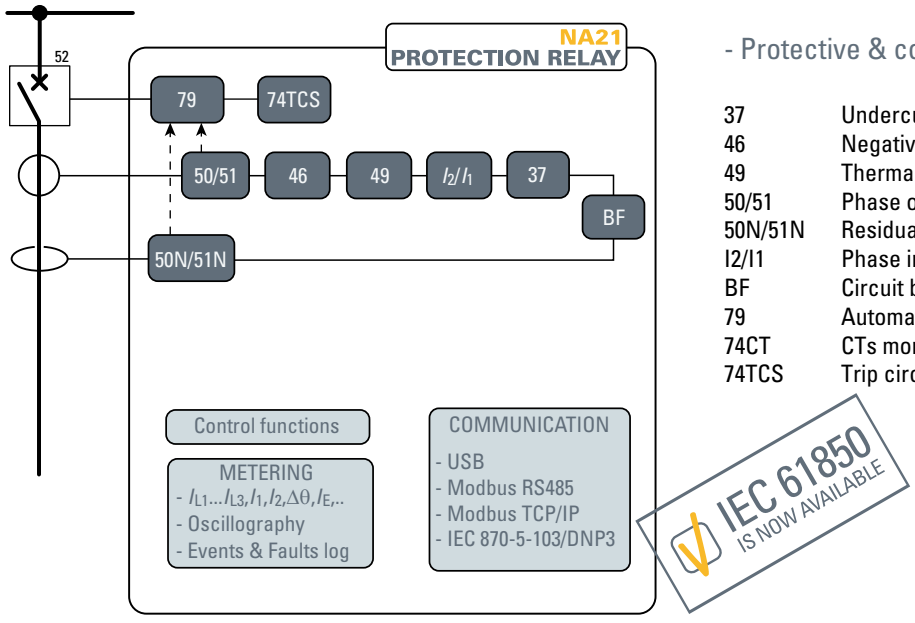
THE BASIC SOLUTION FOR FEEDERS AND TRANSFORMERS
PROTECTION WITH THERMAL IMAGE,
NEGATIVE SEQUENCE OVERCURRENT AND AUTOMATIC RECLOSURE

— Application

The relay type NA21 is typically used in HV, MV and LV radial networks as feeder or power transformer protection. In solidly grounded systems the residual overcurrent protection can be used on feeders of any length, while in ungrounded or Petersen coil and/or resistance grounded systems, the residual overcurrent protection can be used on feeders of small length in order to avoid unwanted trippings due to the capacitive current contribution of the feeder on external ground fault.

Beside to the phase and residual overcurrent protection, the following protective functions are provided:

- Thermal image protection of lines and power transformers
- Undercurrent protection for monitoring of CB opening
- Negative sequence protection against asymmetrical short circuits and unbalance loads
- I_2/I_1 protection against phase interruption under low-load condition
- Automatic reclosing.



- Protective & control functions

37	Undercurrent
46	Negative-sequence overcurrent
49	Thermal image
50/51	Phase overcurrent
50N/51N	Residual overcurrent
I2/I1	Phase interruption under low-load condition
BF	Circuit breaker failure
79	Automatic reclosing
74CT	CTs monitoring
74TCS	Trip circuit supervision

— Measuring inputs
Three phase current inputs and one residual current input, with nominal currents independently selectable at 1 A or 5 A through DIP-switches.

— Firmware updating
The use of flash memory units allows on-site firmware updating.

— Two set point profiles (A,B)
Two independent groups of settings are provided. Switching from profiles may be operated by means of MMI, binary input and communication.

— Construction
According to the hardware configurations, the NA21 protection relay can be shipped in various case styles depending on the required mounting options (flush, projecting mounting, rack or with separate operator panel).

— Modular design
In order to extend I/O capability, the NA21 hardware can be customized through external auxiliary modules:
- MRI - Output relays and LEDs
- MID16 - Binary inputs
- MCI - 4...20 mA converter
- MPT - Pt100 probe inputs.

— Binary inputs
Two or five binary inputs are available with programmable active state (active-ON/active-OFF) and programmable timer (active to OFF/ON or ON/OFF transitions).
Several presettable functions can be associated to each input.

— Blocking input/outputs
One output blocking circuit and one input blocking circuit are provided.
The output blocking circuits of one or several Pro_N relays, shunted together, must be connected to the input blocking circuit of the protection relay, which is installed upwards in the electric plant. The output circuit works as a simple contact, whose condition is detected by the input circuit of the upwards protection relay.
For long distances, when high insulation and high EMC immunity is essential, a suitable pilot wire to fiber optic converter (BFO) is available.

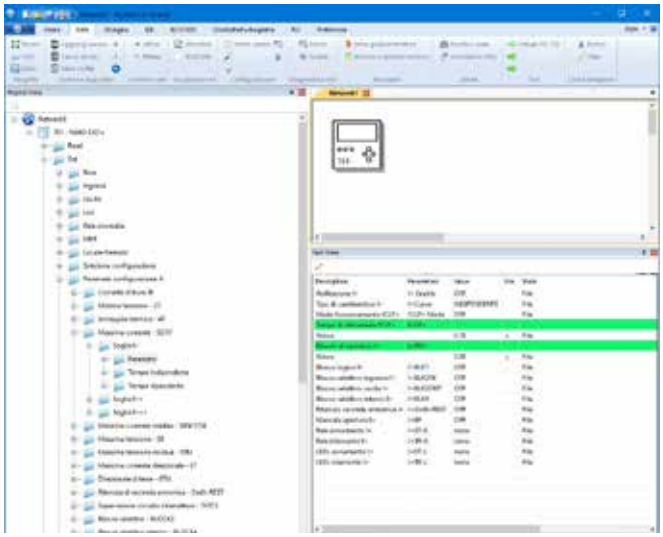
— Output relays
Six output relays are available (two changeover, three make and one break contacts); each relay may be individually programmed as normal state (normally energized, de-energized or pulse) and reset mode (manual or automatic).
A programmable timer is provided for each relay (minimum pulse width). The user may program the function of each relay in accordance with a matrix (tripping matrix) structure.

— MMI (Man Machine Interface)
The user interface comprises a membrane keyboard, a backlight LCD alphanumeric display and eight LEDs.
The green ON LED indicates auxiliary power supply and self diagnostics, two LEDs are dedicated to the Start and Trip (yellow for Start, red for Trip) and five red LEDs are user assignable.

— Communication
Multiple communication interfaces are implemented:
- One USB local communication front-end interface for communication with ThyVisor setup software.
- Two back-end interfaces for communication with remote monitoring and control systems by:
  - RS485 port using ModBus® RTU, IEC 60870-5-103 or DNP3 protocol,
  - Ethernet port (RJ45 or optical fiber) using ModBus/TCP or IEC61850 protocol.

— Programming and settings
All relay programming and adjustment operations may be performed through MMI (Keyboard and display) or using a Personal Computer with the aid of the ThyVisor software.
The same PC setup software is required to set, monitor and configure all Pro_N devices.
Full access to the available data is provided:
- Read status and measures.
- Read/edit settings (on-line or off-line edit).

Two session level (User or Administrator) with password for sensible data access are provided.



— Control and monitoring

Several predefined functions are implemented:
- Circuit Breaker commands and diagnostic.
- Activation of two set point profiles.
- Phase CTs monitoring (74CT).
- Logic selectivity.
- Cold load pickup (CLP) with block or setting change.
- Trip circuit supervision (74TCS).
- Second harmonic restraint (inrush).
- Remote tripping.
- Synchronization.
- Automatic reclosing

Moreover user defined logic must be customized in accordance with IEC 61131-3 protocol by means Programmable Logic Controller.

Circuit Breaker

Several diagnostic, monitoring and control functions are provided:
- Health thresholds can be set; when the accumulated duty (ΣI or ΣI^2t), the number of operations or the opening time exceeds the threshold an alarm is activated.
- Breaker failure (BF); breaker status is monitored by means 52a-52b and/or through line current measurements.
- Trip circuit supervision (74TCS).
- Breaker control; opening and closing commands can be carried out locally or remotely.

Virtual I/O

Through ThySetter and ThyVisor tools the type of operation and links between eight outputs (Virtual Output - VOUT1 ... 8) and ten virtual inputs (Virtual Inputs - VIN1 ... VIN10) may be defined using RPC or IEC 61850 communication protocols over Ethernet network.

The system allows:
- Availability of eight inputs and ten outputs independently programmable by the user
- Simplify wiring using one channel as the Ethernet
- Eliminate the need to install communication devices and / or external conversion
- Significantly reduce costs
- Dynamically change from sw connections and associated functions.

The virtual I / O can be usefully employed for:
- Transmit information between protections installed in distance
- Achieve accelerated logic discrimination in which some protection elements can be blocked by the activation of the downstream protection start
- Circuit Breaker commands, Selection of setting profiles, Remote trip, etc...

Logic selectivity

With the aim of providing a fast selective protection system some protective functions may be blocked.

The selectivity logic may be accomplished by:
- input and output block circuits,
- output relays and logic inputs,
- virtual input and output with messages on Ethernet network.

To guarantee maximum fail-safety, the relay performs a run time monitoring for pilot wire continuity and pilot wire shorting. Exactly the output blocking circuit periodically produces a pulse, with small width in order to be ignored as an effective blocking signal by the input blocking circuit of the upstream protection, but suitable to prove continuity of the pilot wire.

Furthermore a permanent activation (or better, with a duration longer than a preset time) of the blocking signal is identified, as a warning for a possible short circuit in the pilot wire or in the output circuit of the downstream protection.

Cold Load Pickup (CLP)

Cold load pickup element prevents unwanted tripping in case of temporary overcurrents produced when a feeder is being connected after an extended outage (e.g. motor starting).

Two different operating modes are provided:
- Each protective element can be blocked for a setting time.
- Each threshold can be increased for a setting time.

Automatic reclosing

The automatic reclosure function is well-used on overhead lines (when faults are self-extinguish after tripping of protection relays).

The following sequences may be selected:
- Rapid reclosure,
- Rapid reclosure followed by one slow reclosure,
- Rapid reclosure followed by one slow reclosure and one or more delayed reclosures (1...5).

Starting of the automatic reclosing function can be raised by internal protective elements or externally by means binary input signals (eg: external protection device contacts or switches).

The following logics may be set (binary inputs allocation):
- 52a - 52b (Circuit breaker state); the CB position is indispensable for the auto reclosure function.
- Blocking; exclusion command (pulse),
- Enabling; activation command (pulse).
- The following output functions may be coupled to the output relays:
- CB reclosing command;
- Reclosure fail.
- Cycle in progress.

Second harmonic restraint

To prevent unwanted tripping of the protective functions on transformer inrush current, the protective elements can be blocked when the ratio between the second harmonic current and the relative fundamental current is larger than a user programmable threshold. The function can be programmed to switch an output relay so as to cause a blocking protection relays lacking in second harmonic restraint.

— Self diagnostics

All hardware and software functions are repeatedly checked and any anomalies reported via display messages, communication interfaces, LEDs and output relays.

— Metering

NA21 provides metering values for phase and residual currents, making them available for reading on a display or to communication interfaces.

Input signals are sampled 24 times per period and the RMS value of the fundamental component is measured using the DFT (Discrete Fourier Transform) algorithm and digital filtering.

With DFT the RMS value of 2nd, 3rd, 4th and 5th harmonic of phase current are also measured.

On the base of the direct measurements, the fundamental RMS value of the positive and negative sequence currents, the minimum-peak-fixed-rolling demand, mean-minimum-maximum absolute phase currents are processed.

The measured signals can be displayed with reference to nominal values or directly expressed in amperes.

— Event storage

Several useful data are stored for diagnostic purpose; the events are stored into a non volatile memory.

They are graded from the newest to the older after the "Events reading" command (ThyVisor) is issued:
- Sequence of Event Recorder (SER).
  The event recorder runs continuously capturing in circular mode the last three hundred events upon trigger of binary input/output.
- Sequence of Fault Recorder (SFR).
  The fault recorder runs continuously capturing in circular mode the last twenty faults upon trigger of binary input/output and/or element pickup (start-trip).
- Trip counters.

— Digital Fault Recorder (Oscillography)

Upon trigger of tripping/starting of each function or external signals, the relay records in COMTRADE format:
- Oscillography with instantaneous values for transient analysis.
- RMS values for long time periods analysis.
- Logic states (binary inputs and output relays).

Note - A license for Digital Fault Recorder function is required, for purchase procedure please contact Thytronic. The records are stored in nonvolatile memory

SPECIFICATIONS

GENERAL

— Mechanical data

Mounting:	flush, projecting, rack or separated operator panel
Mass (flush mounting case)	2.0 kg

— Insulation tests

Reference standards	EN 60255-5
High voltage test 50Hz	2 kV 60 s
Impulse voltage withstand (1.2/50 µs)	5 kV
Insulation resistance	>100 MΩ

— Voltage dip and interruption

Reference standards	EN 61000-4-29

— EMC tests for interference immunity

1 MHz damped oscillatory wave	EN 60255-22-1	1 kV-2.5 kV
Electrostatic discharge	EN 60255-22-2	8 kV
Fast transient burst (5/50 ns)	EN 60255-22-4	4 kV
Conducted radio-frequency fields	EN 60255-22-6	10 V
Radiated radio-frequency fields	EN 60255-4-3	10 V/m
High energy pulse	EN 61000-4-5	2 kV
Magnetic field 50 Hz	EN 61000-4-8	1 kA/m
Damped oscillatory wave	EN 61000-4-12	2.5 kV
Ring wave	EN 61000-4-12	2 kV
Conducted common mode (0...150 kHz)	EN 61000-4-16	10 V

— Emission

Reference standards	EN 61000-6-4 (ex EN 50081-2)
Conducted emission 0.15...30 MHz	Class A
Radiated emission 30...1000 MHz	Class A

— Climatic tests

Reference standards	IEC 60068-x, ENEL R CLI 01, CEI 50

— Mechanical tests

Reference standards	EN 60255-21-1, 21-2, 21-3

— Safety requirements

Reference standards	EN 61010-1
Pollution degree	3
Reference voltage	250 V
Overvoltage	III
Pulse voltage	5 kV
Reference standards	EN 60529
Protection degree:	
• Front side	IP52
• Rear side, connection terminals	IP20

— Environmental conditions

Ambient temperature	-25...+70 °C
Storage temperature	-40...+85 °C
Relative humidity	10...95 %
Atmospheric pressure	70...110 kPa

— Certifications

Product standard for measuring relays	EN 50263
CE conformity	
• EMC Directive	89/336/EEC
• Low Voltage Directive	73/23/EEC
Type tests	IEC 60255-6

COMMUNICATION INTERFACES

Local PC USB	Type B
Network:	
• RS485	1200...57600 bps
• Ethernet 100BaseT	100 Mbps
Protocol	ModBus® RTU/IEC 60870-5-103/DNP3, TCP/IP, IEC61850

INPUT CIRCUITS

— Auxiliary power supply Uaux

Nominal value (range)	24...48 Vac/dc, 115...230 Vac/110...220 Vdc
Operative range (each one of the above nominal values)	19...60 Vac/dc 85...265 Vac/75...300 Vdc
Power consumption:	
• Maximum (energized relays, Ethernet TX)	10 W (20 VA)
• Maximum (energized relays, Ethernet FX)	15 W (25 VA

— Phase current inputs

Nominal current I_n	1 A or 5 A selectable by DIP Switches
Permanent overload	25 A
Thermal overload (1s)	500 A
Rated consumption (for any phase)	≤ 0.002 VA (I_n = 1 A) ≤ 0.04 VA (I_n = 5 A)

— Residual current input

Nominal current I_{En}	1 A or 5 A selectable by DIP Switch
Permanent overload	25 A
Thermal overload (1s)	500 A
Rated consumption	≤ 0.006 VA (I_{En} = 1 A) ≤ 0.012 VA (I_{En} = 5 A)

— Binary inputs

Quantity	2 or 5
Type	dry inputs
Max permissible voltage	19...265 Vac/19...300 Vdc
Max consumption, energized	3 mA

— Block input (Logic selectivity)

Quantity	1
Type	polarized wet input (powered by internal isolated supply)
Max consumption, energized	5 mA

OUTPUT CIRCUITS

— Output relays K1...K6

Quantity	6
• Type of contacts K1, K2	changeover (SPDT, type C)
• Type of contacts K3, K4, K5	make (SPST-NO, type A)
• Type of contacts K6	break (SPST-NC, type B)
Nominal current	8 A
Nominal voltage/max switching voltage	250 Vac/400 Vac
Breaking capacity:	
• Direct current (L/R = 40 ms)	50 W
• Alternating current (λ = 0,4)	1250 VA
Make	1000 W/VA
Short duration current (0,5 s)	30 A

— Block output (Logic selectivity)

Quantity	1
Type	optocoupler

— LEDs

Quantity	8
• ON/fail (green)	1
• Start (yellow)	1
• Trip (red)	1
• Allocatable (red)	5

GENERAL SETTINGS

— Rated values

Relay nominal frequency f_n	50, 60 Hz
Relay phase nominal current I_n	1 A, 5 A
Phase CT nominal primary current I_{np}	1 A...10 kA
Relay residual nominal current I_{En}	1 A, 5 A
Residual CT nominal primary current I_{Enp}	1 A...10 kA

— Binary input timers

ON delay time (IN1 t_{ON}, IN2 t_{ON}, ...IN5 t_{ON})	0.00...100.0 s
OFF delay time (IN1 t_{OFF}, IN2 t_{OF},...IN5 t_{OFF})	0.00...100.0 s

— Relay output timers

Minimum pulse width t_{TR}	0.000...0.500 s

PROTECTIVE FUNCTIONS

— Base current - IB

Base current (I_B) 0.10...2.50 I_n

Note 1: assuming that the secondary rated current of the line CT's equals the rated current of the NA21 relay, the I_B value is the ratio between the rated current of the protected component and the CT's primary rated current.

— Thermal protection with RTD thermometric probes - 26

Alarm
- Alarm threshold θ_{ALx} (x=1...8) 0...200 °C
- Operating time $t_{\theta ALx}$ (x=1...8) 0....100 s

Trip
- Trip threshold $\theta>_x$ (x=1...8) 0...200 °C
- Operating time $t_{\theta}>_x$ (x=1...8) 0....100 s

— *Note: The element becomes available when the MPT module is enabled and connected to Thybus*

— Undercurrent - 37

Common configuration:
- 37 Operating logic (*Logic*37) AND/OR

I< Element
Definite time
- 37 First threshold definite time ($I<_{def}$) 0.10...1.00 I_n
- $I<_{def}$ Operating time ($t<_{def}$) 0.04...200 s

— Negative sequence - 46

I_2> Element
- I_2> Curve type DEFINITE
  IEC/BS A, B, C - ANSI/IEEE MI, VI, EI, I^2t or EM
- I_{2CLP}> Activation time ($t_{2CLP>}$) 0.00...100.0 s
- I_2> Reset time delay ($t_{2>RES}$) 0.00...100.0 s

Definite time
- 46 First threshold definite time ($I_{2>def}$) 0.100...10.00 I_n
- $I_{2>def}$ within CLP ($I_{2CLP>def}$) 0.100...10.00 I_n
- $I_{2>def}$ Operating time ($t_{2>def}$) 0.03...200 s

Inverse time
- 46 First threshold inverse time ($I_{2>inv}$) 0.100...10.00 I_n
- $I_{2>inv}$ within CLP ($I_{2CLP>inv}$) 0.100...10.00 I_n
- $I_{2>inv}$ Operating time ($t_{2>inv}$) 0.02...60.0 s

I_2>> Element
- I_{2CLP}>> Activation time ($t_{2CLP>>}$) 0.00...100.0 s
- I_2>> Reset time delay ($t_{2>>RES}$) 0.00...100.0 s

Definite time
- 46 Second threshold definite time ($I>>_{def}$) 0.100...40.00 I_n
- $I_{2>>def}$ within CLP ($I_{2CLP>>def}$) 0.100...40.00 I_n
- $I_{2>>def}$ Operating time ($t_{2>>def}$) 0.03...10.00 s

— Thermal image - 49

Common configuration:
- Initial thermal image $\Delta\theta_{IN}$ (Dth_{IN}) 0.0...1.0 $\Delta\theta_B$
- Reduction factor at inrush (K_{INR}) 1.0...3.0
- Thermal time constant τ (T) 1...200 min
- DthCLP Activation time (t_{DthCLP}) 0.00...100.0 s

DthAL1 Element
- 49 First alarm threshold $\Delta\theta_{AL1}$ (Dth_{AL1}) 0.3...1.0 $\Delta\theta_B$

DthAL2 Element
- 49 Second alarm threshold $\Delta\theta_{AL2}$ (Dth_{AL2}) 0.5...1.2 $\Delta\theta_B$

Dth> Element
- 49 Trip threshold $\Delta\theta$ ($Dth>$) 1.100...1.300 $\Delta\theta_B$

— Phase overcurrent - 50/51

I> Element
- $I>$ Curve type DEFINITE,
  IEC/BS A, B, C - ANSI/IEEE MI, VI, EI, RECTIFIER, I^2t or EM
- I_{CLP}> Activation time ($t_{CLP>}$) 0.00...100.0 s
- $I>$ Reset time delay ($t>_{RES}$) 0.00...100.0 s

Definite time
- 50/51 First threshold definite time ($I>_{def}$) 0.100...40.0 I_n
- $I>_{def}$ within CLP ($I_{CLP>def}$) 0.100...40.0 I_n
- $I>_{def}$ Operating time ($t>_{def}$) 0.04...200 s

Inverse time
- 50/51 First threshold inverse time ($I>_{inv}$) 0.100...20.00 I_n
- $I>_{inv}$ within CLP ($I_{CLP>inv}$) 0.100...20.00 I_n
- $I>_{inv}$ Operating time ($t>_{inv}$) 0.02...60.0 s

I>> Element
- Type characteristic DEFINITE or I^2t
- I_{CLP}>> Activation time ($t_{CLP>>}$) 0.00...100.0 s
- $I>>$ Reset time delay ($t>>_{RES}$) 0.00...100.0 s

Definite time
- 50/51 Second threshold definite time ($I>>_{def}$) 0.100...40.0 I_n
- $I>>_{def}$ within CLP ($I_{CLP>>def}$) 0.100...40.0 I_n
- $I>>_{def}$ Operating time ($t>>_{def}$) 0.03...10.00 s

Inverse time
- 50/51 Second threshold inverse time ($I>>_{inv}$) 0.100...20.00 I_n
- $I>>_{inv}$ within CLP ($I_{CLP>>inv}$) 0.100...20.00 I_n
- $I>>_{inv}$ Operating time ($t>>_{inv}$) 0.02...10.00 s

I>>> Element
- I_{CLP}>>> Activation time ($t_{CLP>>>}$) 0.00...100.0 s
- $I>>>$ Reset time delay ($t>>>_{RES}$) 0.00...100.0 s

Definite time
- 50/51 Third threshold definite time ($I>>>_{def}$) 0.100...40.0 I_n
- $I>>>_{def}$ within CLP ($I_{CLP>>>def}$) 0.100...40.0 I_n
- $I>>>_{def}$ Operating time ($t>>>_{def}$) 0.03...10.00 s

— Residual overcurrent - 50N/51N

I_E> Element
- I_E> Curve type DEFINITE
  IEC/BS A, B, C - ANSI/IEEE MI, VI, EI or EM
- I_{ECLP}> Activation time ($t_{ECLP>}$) 0.00...100.0 s
- I_E> Reset time delay ($t_{E>RES}$) 0.00...100.0 s

Definite time
- 50N/51N First threshold definite time ($I_{E>def}$) 0.002...10.00 I_{En}
- $I_{E>def}$ within CLP ($I_{ECLP>def}$) 0.002...10.00 I_{En}
- $I_{E>def}$ Operating time ($t_{E>def}$) 0.04...200 s

Inverse time
- 50N/51N First threshold inverse time ($I_{E>inv}$) 0.002...2.00 I_{En}
- $I_{E>inv}$ within CLP ($I_{ECLP>inv}$) 0.002...2.00 I_{En}
- $I_{E>inv}$ Operating time ($t_{E>inv}$) 0.02...60.0 s

I_E>> Element
- I_{ECLP}>> Activation time ($t_{ECLP>>}$) 0.00...100.0 s
- I_E>> Reset time delay ($t_{E>>RES}$) 0.00...100.0 s

Definite time
- 50N/51N Second threshold definite time ($I_{E>>def}$) 0.002...10.00 I_{En}
- $I_{E>>def}$ within CLP ($I_{ECLP>>def}$) 0.02...10.00 I_{En}
- $I_{E>>def}$ Operating time ($t_{E>>def}$) 0.03...10.00 s

I_E>>> Element
- I_{ECLP}>>> Activation time ($t_{ECLP>>>}$) 0.00...100.0 s
- I_{ECLP}>>> Reset time delay ($t_{E>>>RES}$) 0.00...100.0 s

Definite time
- 50N/51N Third threshold definite time ($I_{E>>>def}$) 0.002...10.00 I_{En}
- $I_{ECLP>>>def}$ within CLP ($I_{ECLP>>>def}$) 0.002...10.00 I_{En}
- $I_{ECLP>>>def}$ Operating time ($t_{E>>>def}$) 0.03...10.00 s

— Negative sequence current / positive sequence current ratio - I_2/I_1

I_{21}> Element
- I_{21CLP}> Activation time ($t_{21CLP>}$) 0.00...100.0 s

Definite time
- I_2/I_1 First threshold definite time ($I_{21>def}$) 0.10...1.00
- $I_{21>def}$ within CLP ($I_{21CLP>def}$) 0.10...1.00
- $I_{21>def}$ Operating time ($t_{21>def}$) 0.04...15000 s

— CT supervision - 74CT

74CT Threshold ($S<$) 0.10...0.95
74CT Overcurrent threshold ($I*$) 0.10..1.00 I_n
$S<$ Operating time ($t_S<$) 0.03...200 s

— Second Harmonic Restraint - 2ndh-REST

Second harmonic restraint threshold (I_{2ndh}>) 10...50 %
I_{2ndh}> Reset time delay ($t_{2ndh>RES}$) 0.00...100.0 s

— Selective block - BLOCK2

Selective block IN:
- BLIN Max activation time for phase protections ($t_{B\text{-}IPh}$) 0.10...10.00 s
- BLIN Max activation time for earth protections ($t_{B\text{-}IE}$) 0.10...10.00 s

Selective block OUT:
- BLOUT1 Dropout time delay for phase protections ($t_{F\text{-}IPh}$) 0.00...1.00 s
- BLOUT1 Drop-out time delay for phase protections ($t_{F\text{-}IE}$) 0.00...1.00 s
- BLOUT1 Drop-out time delay for phase and earth protections ($t_{F\text{-}IPh/IE}$) 0.00...1.00 s

— Auto-reclose - 79

79 Function mode (*79 Mode*)	Rapid/Rapid+Slow
Number of delayed reclosures (*N.DAR*)	0...5
Rapid reclosure dead time (t_{rdt})	0.1...60 s
Slow reclosure dead time (t_{sdt})	1...200 s
Reclaim time (t_r)	1...200 s
Slow reclosure fault discrimination time (t_{d1})	0...10 s
Delayed reclosure fault discrimination time (t_{d2})	0...10 s
Manual close (R+S only) fault discrimination time (t_d)	1...10 s

— Breaker failure - BF

BF Phase current threshold ($I_{BF>}$)	0.05...1.00 I_n
BF Residual current threshold ($I_{EBF>}$)	0.01..2.00 I_{En}
BF Time delay (t_{BF})	0.06...10.00 s

— Circuit Breaker supervision

Number of CB trips threshold (*N.Open*)	0...10000
Cumulative CB tripping currents threshold (*SumI*)	0...5000 I_n
CB opening time for I^2t calculation (t_{break})	0.05...1.00 s
Cumulative CB tripping I^2t threshold (*SumI^2t*)	0...5000 $(I_n)^2 \cdot s$
CB maximum allowed opening time ($t_{break>}$)	0.05...1.00 s

— Pilot wire diagnostic

BLOUT1 Diagnostic pulses period (*PulseBLOUT1*)
OFF - 0.1-1-5-10-60-120 s

BLIN1 Diagnostic pulses control time interval (*PulseBLIN1*)
OFF - 0.1-1-5-10-60-120 s

METERING & RECORDING

Measured parameters

Direct:
- Frequency — f
- Fundamental RMS phase currents — I_{L1}, I_{L2}, I_{L3}
- Fundamental RMS residual current — I_E

Calculated:
- Thermal image — DTheta
- Maximum current between I_{L1}-I_{L2}-I_{L3} — I_{Lmax}
- Minimum current between I_{L1}-I_{L2}-I_{L3} — I_{Lmin}
- Average current between I_{L1}-I_{L2}-I_{L3} — I_L

Sequence:
- Positive sequence current — I_1
- Negative sequence current — I_2
- Negative sequence current/positive sequence current ratio — I_2/I_1

2nd harmonic:
- Second harmonic phase currents — $I_{L1\text{-}2nd}$, $I_{L2\text{-}2nd}$, $I_{L3\text{-}2nd}$
- Second harmonic phase currents/fundamental component percentage ratio — $I_{\text{-}2nd}/I_L$

3rd harmonic:
- Third harmonic phase currents — $I_{L1\text{-}3rd}$, $I_{L2\text{-}3rd}$, $I_{L3\text{-}3rd}$
- Third harmonic of residual current — $I_{E\text{-}3rd}$

4th harmonic:
- Fourth harmonic phase currents — $I_{L1\text{-}4th}$, $I_{L2\text{-}4th}$, $I_{L3\text{-}4th}$

5th harmonic:
- Fifth harmonic phase currents — $I_{L1\text{-}5th}$, $I_{L2\text{-}5th}$, $I_{L3\text{-}5th}$

On demand:
- Phase fixed currents demand — I_{L1FIX}, I_{L2FIX}, I_{L3FIX}
- Phase rolling currents demand — I_{L1ROL}, I_{L2ROL}, I_{L3ROL}
- Phase peak currents demand — I_{L1MAX}, I_{L2MAX}, I_{L3MAX}
- Phase minimum currents demand — I_{L1MIN}, I_{L2MIN}, I_{L3MIN}

Pt100:
- PT1...PT8 Temperature — T_1... T_8

— Event recording (SER)

Number of events	300
Recording mode	circular

Trigger:
- Start/Trip of enabled protection or control element
- Binary inputs switching (OFF/ON or ON/OFF) IN1...INx
- Setting changes
- Auxiliary supply Power UP/Power DOWN

Data recorded:
- Counter (resettable by ThyVisor) 0...10^9
- Cause binary input/trip/setting change/Power ON/OFF
- Time stamp Date and time

— Fault recording (SFR)

Number of faults	20
Recording mode	circular

Trigger:
- Output relays of enabled protection or control element (OFF-ON)
- External trigger (binary inputs) IN1...INx

Data recorded:
- Counter (resettable by ThyVisor) 0...10^9
- Time stamp Date and time
- Cause tripped element
- Fundamental RMS phase currents I_{L1r}, I_{L2r}, I_{L3r}
- Fundamental RMS of measured residual current (CTs) I_{Er}
- Thermal image *DTheta*-r
- Negative sequence current / positive sequence current ratio $(I_2/I_1)_r$
- Binary inputs state IN1, IN2...INx
- Output relays state K1...K6...K10
- Fault cause info (operating phase) L1, L2, L3

— Digital Fault Recorder (Oscillography) [1]

File format	COMTRADE
Records	depending on setting [2]
Recording mode	circular
Sampling rate	24 per power frequency cycle

Trigger setup:
- Pre-trigger time 0.05...1.00 s
- Post-trigger time 0.05...60.00 s
- Trigger from inputs IN1, IN2...INx
- Trigger from outputs K1...K6...K10
- Manual trigger ThyVisor

Set sample channels:
- Instantaneous currents — i_{L1}, i_{L2}, i_{L3}, i_E

Set analog channels (Analog 1...12):
- Frequency — f
- Phase current RMS values — I_{L1}, I_{L2}, I_{L3}
- Residual current RMS value — I_E
- Positive and negative sequence currents — I_1 , I_2
- Negative sequence current/positive sequence current ratio — I_2/I_1
- Second harmonic currents — $I_{L1\text{-}2nd}$, $I_{L2\text{-}2nd}$, $I_{L3\text{-}2nd}$
- Maximum of the second harmonic phase currents/fundamental component percentage ratio — $I_{\text{-}2nd}/I_L$
- Temperature — *T1...T8*

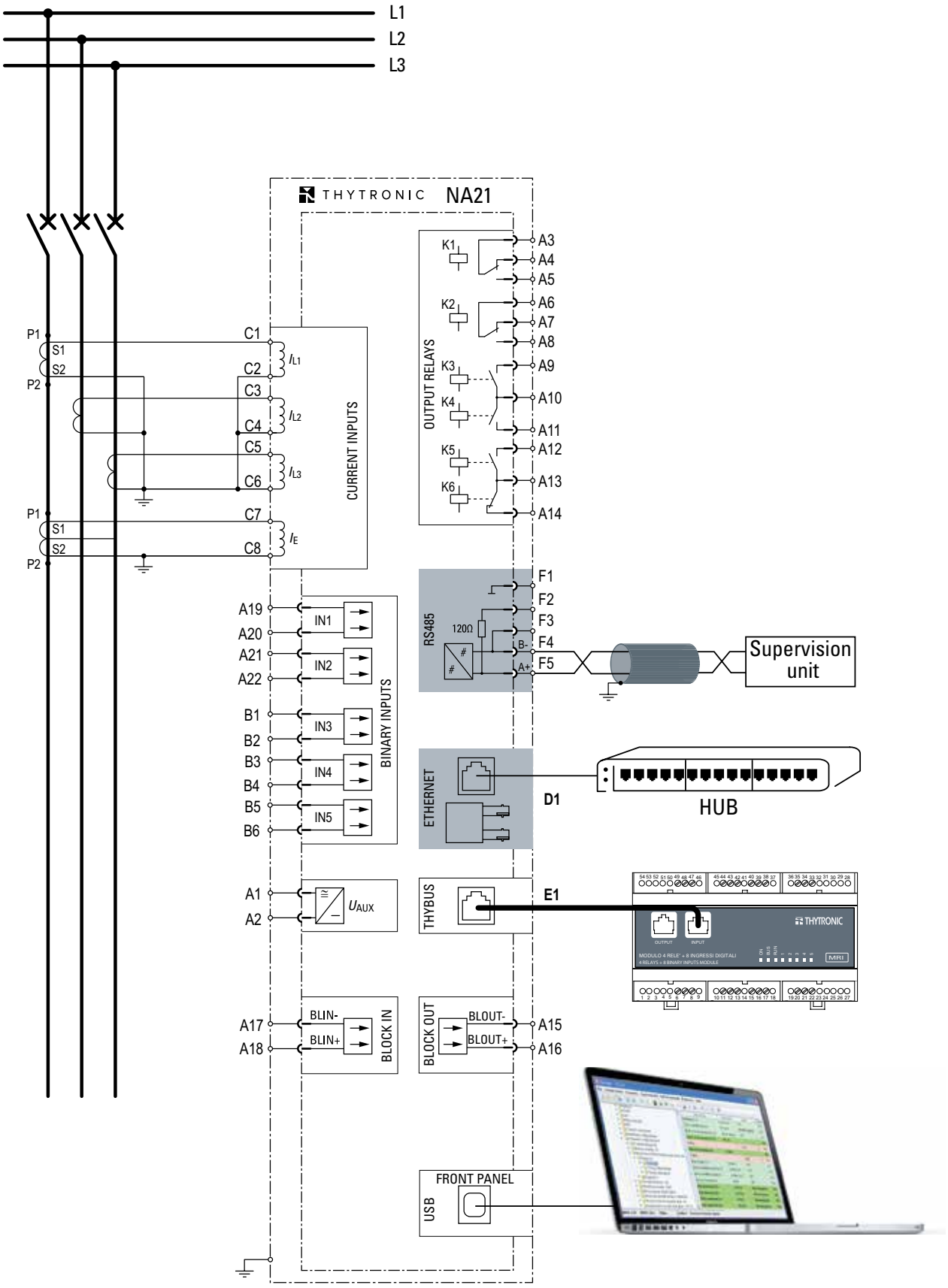
Set digital channels (Digital 1...12):
- Output relays state K1...K6...K10
- Binary inputs state IN1, IN2...INx

Note 1- A licence for the digital fault recorder function is required. The oscillography records are stored in non-volatile memory.

Note 2 - For instance, with following setting:
- *Pre-trigger time* — *0.25 s*
- *Post-trigger time* — *0.25 s*
- *Sampled channels* — i_{L1}, i_{L2}, i_{L3}, i_E
- *Analog channels* — I_{L1}, I_{L2}, I_{L3}, I_E
- *Digital channels* — *K1, K2, K3, K4, K5, K6, IN1, IN2*

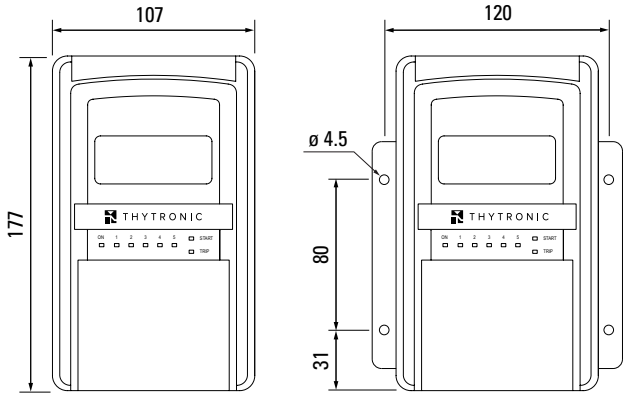
up to 180 records can be stored when f = 50 Hz

— Connection diagram example



DIMENSIONS

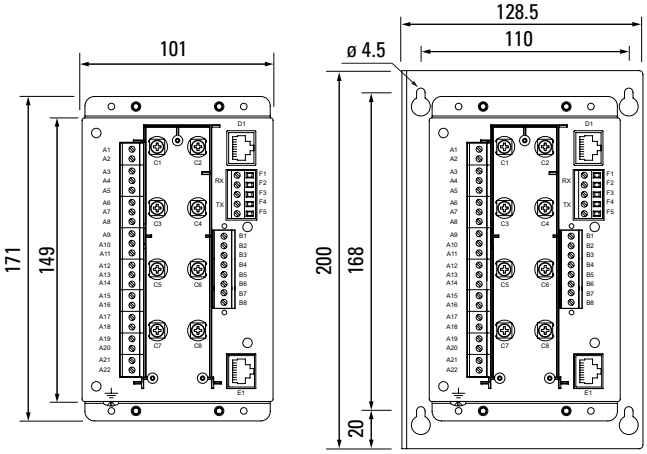
FRONT VIEW



FLUSH MOUNTING

PROJECTING MOUNTING

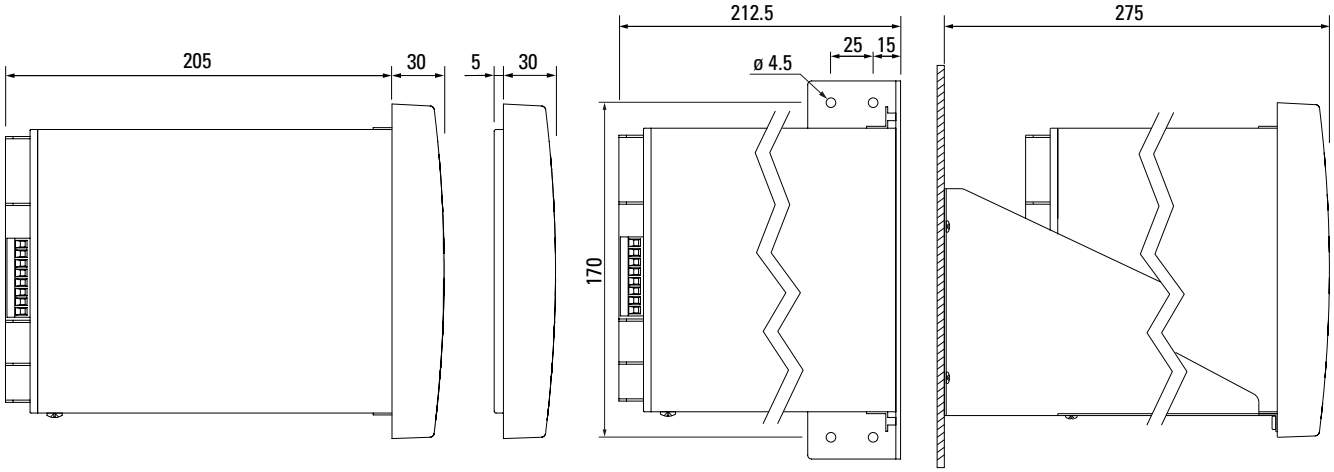
REAR VIEW



FLUSH MOUNTING

PROJECTING MOUNTING
(Separate operator panel)

SIDE VIEW



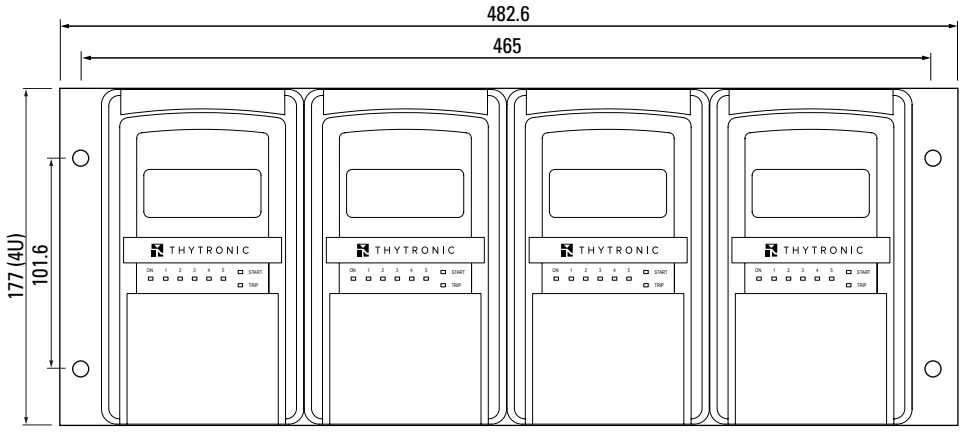
FLUSH MOUNTING

SEPARATE
OPERATOR PANEL

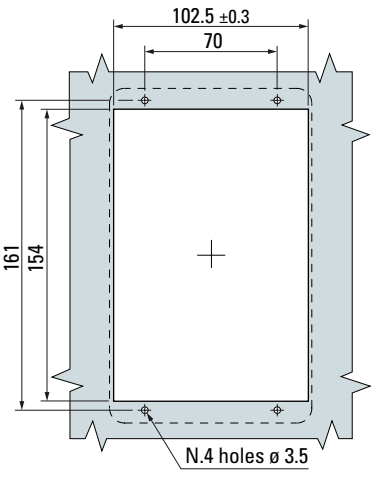
PROJECTING MOUNTING
(Separate operator panel)

PROJECTING MOUNTING
(Stand alone)

RACK MOUNTING



FLUSH MOUNTING CUTOUT



Headquarter: 20139 Milano - Piazza Mistral, 7 - Tel. +39 02 574 957 01 ra - Fax +39 02 574 037 63
Factory: 35127 Padova - Z.I. Sud - Via dell'Artigianato, 26 - Tel. +39 049 894 770 1 ra - Fax +39 049 870 139 0

www.thytronic.it **www.thytronic.com** **thytronic@thytronic.it**